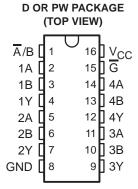
SN74LVC157A-Q1 **QUADRUPLE 2-LINE TO 1-LINE DATA SELECTOR/MULTIPLEXER**

SCAS716B - SEPTEMBER 2003 - REVISED MAY 2004

- **Qualification in Accordance With** AEC-Q100†
- **Qualified for Automotive Applications**
- **Customer-Specific Configuration Control** Can Be Supported Along With Major-Change Approval
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Operates From 2 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max tpd of 5.4 ns at 3.3 V
- **Typical V_{OLP} (Output Ground Bounce)** <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$

Typical V_{OHV} (Output V_{OH} Undershoot) >2 V at V_{CC} = 3.3 V, T_A = 25°C



description/ordering information

The SN74LVC157A quadruple 2-line to 1-line data selector/multiplexer is designed for 2.7-V to 3.6-V V_{CC} operation.

The device features a common strobe (\overline{G}) input. When \overline{G} is high, all outputs are low. When \overline{G} is low, a 4-bit word is selected from one of two sources and is routed to the four outputs. The device provides true data.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

ORDERING INFORMATION

TA	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 125°C	SOIC - D	Tape and reel	SN74LVC157AQDRQ1	L157AQ1	
	TSSOP - PW	Tape and reel	SN74LVC157AQPWRQ1	L157AQ1	

[‡] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

	INPU		OUTPUT	
G	Ā/B	Α	В	Υ
Н	Х	Χ	Χ	L
L	L	L	X	L
L	L	Н	X	Н
L	Н	Χ	L	L
L	Н	Χ	Н	Н



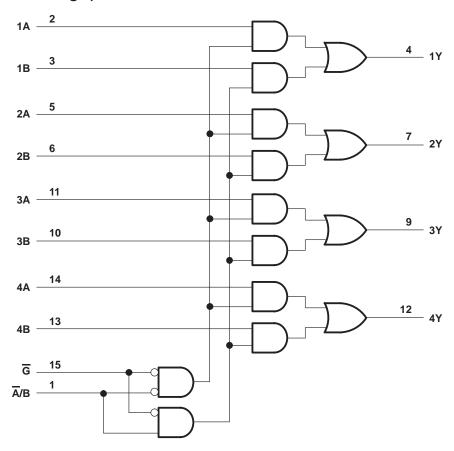
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[†] Contact factory for details. Q100 qualification data available on request.

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 6.5 V
Input voltage range, V _I (see Note 1	1)	0.5 V to 6.5 V
Output voltage range, VO (see Not	tes 1 and 2)	\dots -0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)		–50 mA
Output clamp current, I _{OK} (V _O < 0))	–50 mA
Continuous output current, IO	·	±50 mA
Continuous current through V _{CC} o	r GND	±100 mA
Package thermal impedance, θ _{JA} ((see Note 3): D package	
	PW package .	108°C/W
Storage temperature range, T _{sto}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of V_{CC} is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
.,	Supply voltage	Operating	2	3.6	.,	
VCC		Data retention only	1.5		V	
VIH	High-level input voltage	V _{CC} = 2.7 V to 3.6 V	2		V	
VIL	Low-level input voltage	V _{CC} = 2.7 V to 3.6 V		8.0	V	
VI	Input voltage		0	5.5	V	
٧o	Output voltage		0	VCC	V	
		V _{CC} = 2.7 V		-12		
ЮН	High-level output current	VCC = 3 V		-24	mA	
		V _{CC} = 2.7 V		12	4	
lOL	Low-level output current	VCC = 3 V		24	mA	
Δt/Δν	Input transition rise or fall rate			10	ns/V	
TA	Operating free-air temperature		-40	125	°C	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARA	METER	TEST CONDITIONS	VCC	MIN	MAX	UNIT
		I _{OH} = -100 μA	2.7 V to 3.6 V	V _{CC} -0.2	2	
.,			2.7 V	2.2		V
VOH		$I_{OH} = -12 \text{ mA}$	3 V	2.4		
		$I_{OH} = -24 \text{ mA}$	3 V	2.2		
		I _{OL} = 100 μA	2.7 V to 3.6 V		0.2	
VOL		I _{OL} = 12 mA	2.7 V		0.4	V
~-		I _{OL} = 24 mA	3 V		0.55	
lį	All inputs	V _I = 5.5 V or GND	3.6 V		±5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	3.6 V		10	μΑ
ΔlCC		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V		500	μΑ

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

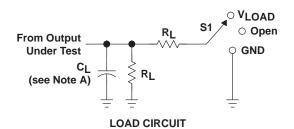
PARAMETE	FROM	TO (OUTPUT)	V _{CC} = 2.7 V	V _{CC} =	V _{CC} = 3.3 V ± 0.3 V	
	(INPUT)	(OUTPUT)	MIN MA	MIN	MAX	
	A or B		6.	2 0.8	5.4	
t _{pd}	Ā/B	Y	8.	2 0.8	7	ns
·	G		7.	0.8	6.5	

operating characteristics, T_A = 25°C

	PARAMETER		V _{CC} = 2.5 V	V _{CC} = 3.3 V	LINUT
	TANAMETEN	CONDITIONS	TYP	TYP	UNIT
C _{pd}	Power dissipation capacitance	f = 10 MHz	15	16	pF

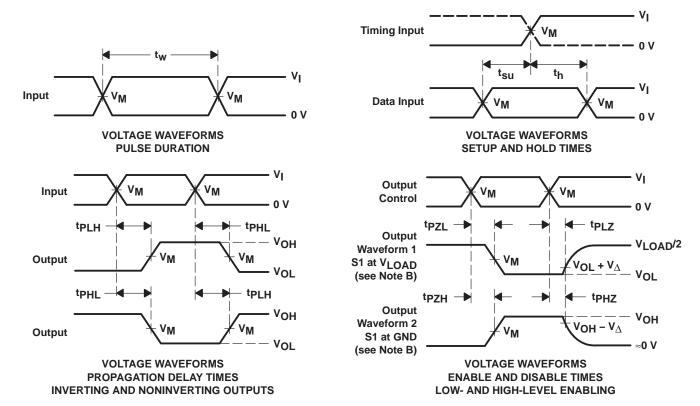


PARAMETER MEASUREMENT INFORMATION



TEST	S1
tPLH/tPHL	Open
tPLZ/tPZL	VLOAD
tPHZ/tPZH	GND

.,	INPUTS		.,	v	0	Б.	V
VCC	VI	t _r /t _f	VM	VLOAD	CL	RL	$v_{\scriptscriptstyle\Delta}$
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzI and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

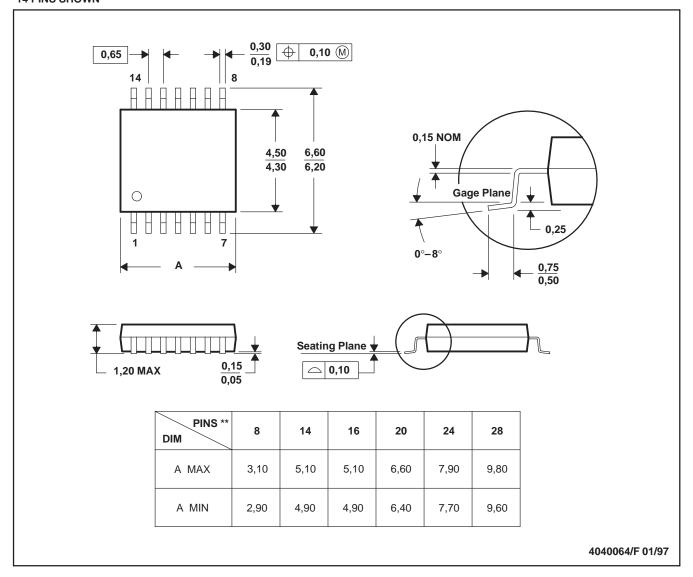
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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